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**Sheet Title:** ADC1, ADC2 INPUTS

**File:** ADC1, ADC2 INPUTS.SchDoc

- **Sheet:** 4
- **Design:** AFE-MERGING UNIT

**Components:**
- R118, R119, R120, R121, R129, R130, R132
- R141, R146, R147, R148
- R150
- R151

**Connectors:**
- J15, J16, J13, J7, J8, J12, J10, J3, J1

**Other Elements:**
- SGND

**Symbols:**
- TP22
- 1000pF
- C0
- C1

**Drawn By:** Srinivas K.
Fiducials

Mounting holes

PCB Number: TDA-00307
PCB Rev: E2

PCB Logo
Texas Instruments

LI8.1
PCB Label
Scale: 0.001 = 0.001

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive. ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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